

NCE60TD60BT

600V, 60A, Trench FS II Fast IGBT

General Description:

Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

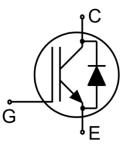
Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives

Wuxi NCE Power Co., Ltd



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking		
NCE60TD60BT	TO-247	NCE60TD60BT		



TO-247

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Units	
Vces	Collector-Emitter Voltage	600	V	
V_{GES}	Gate- Emitter Voltage	±30	V	
	Collector Current	120	A	
lc	Collector Current @T _C = 100 °C	60	A	
I _{Cplus}	Pulsed Collector Current, t _p limited by T _{jmax}	180	A	
-	turn off safe operating area, V _{CE} =600V, Tj=150°C	180	A	
I _F	Diode Continuous Forward Current @T _C = 100 °C	60	A	
I _{FM}	Diode Maximum Forward Current	180	A	
Б	Power Dissipation @ T _C = 25°C	316	W	
P _D	Power Dissipation @T _C = 100 °C	158	W	
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C	
TL	Maximum Temperature for Soldering	260	°C	
t _{sc}	Short circuit withstand time V _{GE} =15V, V _{CC} ≤400V, Allowed number of short circuits<1000Time between short circuits:≥1.0s,T _j ≤150°C	5	us	



Thermal Characteristic

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	0.47	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	1.72	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

0	Daniel de la constante de la c	Test Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics						
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
Ices	Collector-Emitter Leakage Current	V _{GE} =0V,V _{CE} =600V				5	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30V,V _{CE} =0V				200	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30	V,Vce =0V			200	nA
\ /	O-III- star Fraitter O-torretion Vallage	Ic=60A	Tj=25°C		1.7	1.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15V$	Tj=150°C		1.9		V
V _{GE(th)}	Gate Threshold Voltage	Ic=1mA	,Vce=Vge	4.0	5.0	6.0	V
Dynamic Cha	aracteristics						
Cies	Input Capacitance				7018		
Coes	Output Capacitance		/,V _{GE} =0V,		199		pF
C _{res}	Reverse Transfer Capacitance	f=1MHz			138		
Qg	Total Gate Charge	Vcc=480V, Ic=60A V _{GE} =15V			262		nC
Qge	Gate to Emitter Charge				60		
Q _{gc}	Gate to Collector Charge				113		
Ic(sc)	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V,V _{CC} ≤400V, t _{SC} ≤5us,Tj≤150°C			360		А
Switching Cl	haracteristics						
t _{d(ON)}	Turn-on Delay Time				19		
tr	Rise Time				17		20
t _{d(OFF)}	Turn-Off Delay Time	V_{CC} =400V,Ic=60A V_{GE} =0/15V, R_{g} =5 Ω			170		ns
t _f	Fall Time				18		
Eon	Turn-On Switching Loss	Induct	ve Load		2.2		
E _{off}	Turn-Off Switching Loss				0.9		mJ
E _{ts}	Total Switching Loss				3.1		

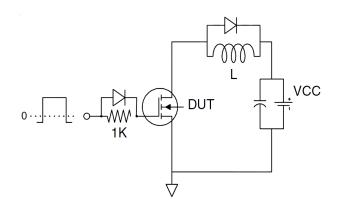
Electrical Characteristics of the Diode (Tc= 25°C unless otherwise specified):

Symbol	Parameter	Test Conditions	Rating			Units
Symbol			Min.	Тур.	Max.	Ullits
V _{FM}	Diode Forward Voltage	I _F =60A		1.7	2.0	V
Trr	Reverse Recovery Time			186		ns
I _{RRM}	Diode Peak Reverse Recovery Current	I _F =60A, di/dt=200A/us		3.8		А
Qrr	Reverse Recovery Charge			0.3		uC
Pulse width $t_{tp} \le 380 \mu s, \delta \le 2\%$						

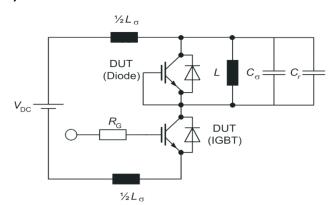


Test Circuit

1) Gate Charge Test Circuit

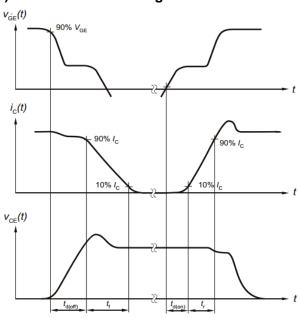


2) Switch Time Test Circuit

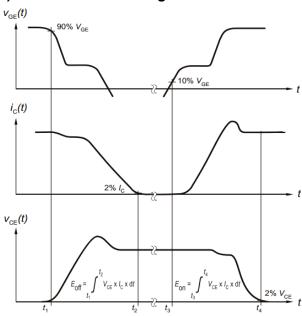


Switching characteristics

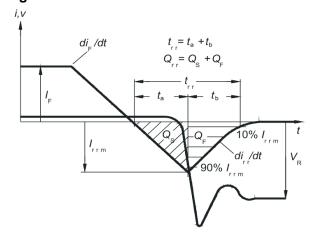
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

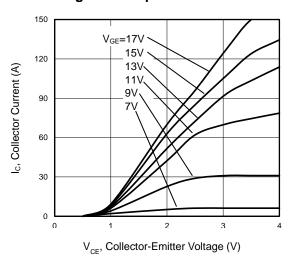


Figure 3 V_{CEsat} vs. Case Temperature

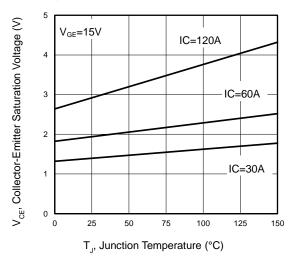


Figure 5 Capacitance Characteristics

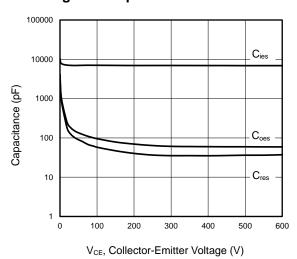


Figure 2 Transfer Characteristics

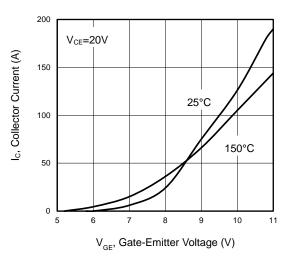


Figure 4 Saturation Voltage vs. V_{GE}

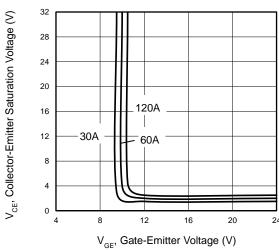
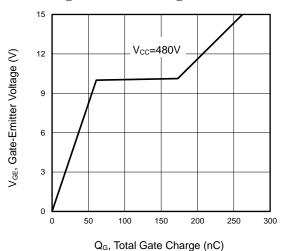


Figure 6 Gate charge waveform



V2.0



Typical Electrical and Thermal Characteristics

Figure 7 Forward Characteristics

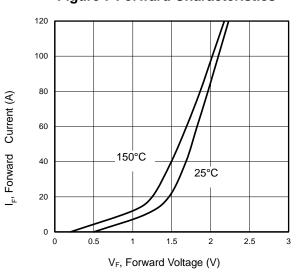


Figure 9 Typical Switching Times as a Function of Gate Resistor

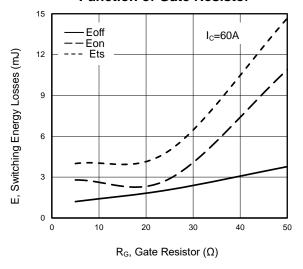


Figure 11 Gate-emitter Threshold Voltage as a Function of Junction Temperature

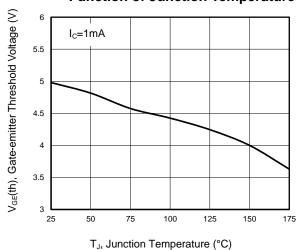


Figure 8 V_F vs. temperature

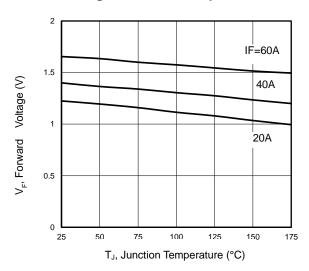


Figure 10 Typical Switching Times as a Function of Junction Temperature

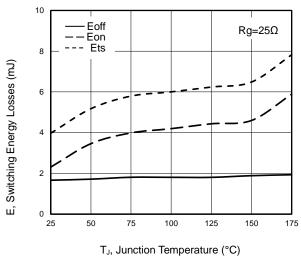
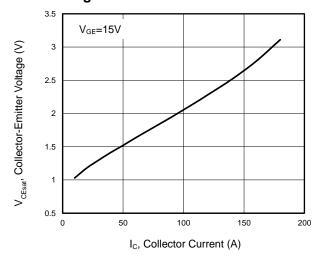


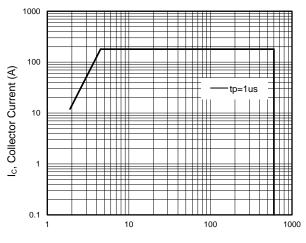
Figure 12 Typical Collector-emitter Saturation
Voltage as a function of Collector Current





Typical Electrical and Thermal Characteristics

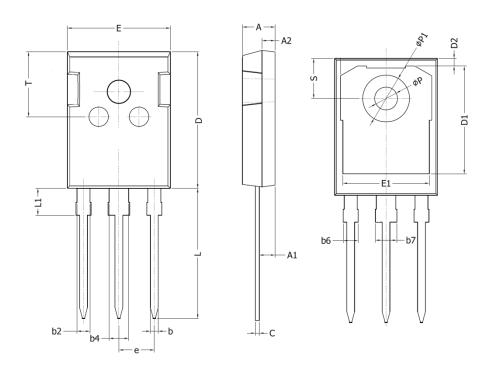
Figure 13 Forward Bias Safe Operating Area



V_{CE}, Collector-Emitter Voltage (V)



TO-247-3L Package Information



Cumbal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.90	5.10	0.193	0.201	
A1	2.31	2.51	0.091	0.099	
A2	1.9	2.1	0.075	0.083	
b	1.16	1.26	0.046	0.050	
b2	1.96	2.06	0.077	0.081	
b4	2.96	3.06	0.117	0.120	
b6	-	2.25	-	0.089	
b7	-	3.25	-	0.128	
С	0.59	0.66	0.023	0.026	
D	20.90	21.10	0.823	0.831	
D1	16.25	16.85	0.640	0.663	
D2	1.05	1.35	0.041	0.053	
Е	15.70	15.90	0.618	0.626	
E1	13.10	13.50	0.516	0.531	
е	5.436	BSC	0.214 BSC		
L	19.80	20.10	0.780	0.791	
L1	-	4.30	-	0.169	
Р	3.40	3.60	0.134	0.142	
P1	7.00	7.40	0.276	0.291	
S	6.05	6.25	0.238	0.246	
Т	9.80	10.20	0.386	0.402	



NCE60TD60BT

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